April 2013



FGAF40N60SMD 600 V, 40 A Field Stop IGBT

Features

- Maximum Junction Temperature : T_J = 175^oC
- Positive Temperaure Co-efficient for easy Parallel Operating
- High Current Capability
- + Low Saturation Voltage: $V_{CE(sat)}$ = 1.9 V(Typ.) @ I_C = 40 A
- High Input Impedance
- Fast Swiching: E_{OFF} = 6.5 uJ/A
- Tightened Parameter Distribution
- RoHS Compliant

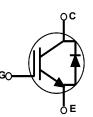
Applications

- Sewing Machine, CNC
- Home Appliances, Motor-Control

General Description

Using novel field stop IGBT technology, Fairchild[®]'s new series of field stop 2nd generation IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.





Absolute Maximum Ratings

Symbol	Description		Ratings	Unit	
V _{CES}	Collector to Emitter Voltage		600	V	
V _{GES}	Gate to Emitter Voltage	± 20	V		
I _C	Collector Current	@ T _C = 25°C	80*	A	
·C	Collector Current	@ T _C = 100 ^o C	40*	A	
I _{CM (1)}	Pulsed Collector Current	120*	A		
I _F	Diode Forward Current	@ T _C = 25°C	40*	A	
	Diode Forward Current	@ T _C = 100 ^o C	20*	A	
I _{FM (1)}	Pulsed Diode Maximum Forward Curre	120*	A		
P _D	Maximum Power Dissipation	@ T _C = 25°C	79	W	
	Maximum Power Dissipation	@ T _C = 100 ^o C	39	W	
TJ	Operating Junction Temperature	-55 to +175	°C		
T _{stg}	Storage Temperature Range	-55 to +175	°C		
ΤL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 second	300	°C		

Notes:

*Drain current limited by maximum junction temperature

1: Repetitive rating: Pulse width limited by max. junction temperature

Symbol Paramete			r	Тур.		b .	Max.		Unit		
R _{0JC} (IGBT)	Theri	Thermal Resistance, Junction to Ca						1.57 0		°C/W	
R _{0JC} (Diode) Theri	Thermal Resistance, Junction to Case				-		3.27	7 ^o C/		
R_{\thetaJA}	Thermal Resistance, Junction to An			nbient	-			40	(°C/W	
Package	e Marki	ing and Orderi	ng In	formatio	n		·		<u>.</u>		
Device N		Device	-	O-3PF -		Tape Width		Quantity			
FGAF40N	60SMD	FGAF40N60SMD	Г					-	30		
Electric		restariation of t	bo l	TOT	1		1		1		
Symbol		Parameter	ine it		°C unless otherwise		Min.	Тур.	Max.	Unif	
Cynisol				1001				196.	max.	0	
Off Charac	teristics										
BV _{CES}	Collector	to Emitter Breakdown V	oltage	V_{GE} = 0V, I_C	= 250µA		600	-	-	V	
$\frac{\Delta BV_{CES}}{\Delta T_{J}}$	Temperat Voltage	ure Coefficient of Break	down	V _{GE} = 0V, I _C = 250μA			-	0.6	-	V/ºC	
I _{CES}	Collector	Cut-Off Current		$V_{CE} = V_{CES}$,	V_{GE} = 0V		-	-	250	μA	
I _{GES}	G-E Leak	age Current		$V_{GE} = V_{GES}, V_{CE} = 0V$			-	-	±400	nA	
On Charac	teristics										
V _{GE(th)}	G-E Three	shold Voltage		I _C = 250μA, V _{CE} = V _{GE}			3.5	4.5	6.0	V	
				I _C = 40A, V _{GE} = 15V			-	1.9	-	V	
V _{CE(sat)}	Collector	Collector to Emitter Saturation Voltage			$I_{C} = 40A, V_{GE} = 15V,$ $T_{C} = 175^{\circ}C$		-	2.1	-	V	
Dynamic C	haractoris	tics		1				I			
C _{ies}	Input Cap						-	1880	-	pF	
C _{oes}		apacitance		V _{CE} = 30V, V _{GE} = 0V,			-	180	-	pF	
C _{res}		· Fransfer Capacitance		f = 1MHz			-	50	-	pF	
103		•									
Switching	1			1			1	1			
t _{d(on)}		Delay Time					-	12	-	ns	
t _r	Rise Time						-	20	-	ns	
t _{d(off)}		Delay Time		$V_{\rm CC} = 400V,$	I _C = 40A,		-	92	-	ns	
t _f	Fall Time			$R_G = 6\Omega$, $V_{GE} = 15V$, Inductive Load, $T_C = 25^{\circ}$ (-	13	17	ns	
E _{on}	Turn-On S	Switching Loss					-	0.87	-	mJ	
E _{off}	Turn-Off S	Switching Loss					-	0.26	0.34	mJ	
E _{ts}	Total Swit	ching Loss						1.13	-	mJ	
t _{d(on)}	Turn-On [Delay Time					-	15	-	ns	
t _r	Rise Time	; ;		V_{CC} = 400V, I _C = 40A, R _G = 6 Ω , V _{GE} = 15V, Inductive Load, T _C = 175			-	22	-	ns	
t _{d(off)}	Turn-Off	Delay Time					-	116	-	ns	
t _f	Fall Time						-	16	-	ns	
Eon	Turn-On S	Switching Loss				,	-	0.97	-	mJ	
E _{off}	Turn-Off S	Switching Loss					-	0.60	-	mJ	
E _{ts}	Total Swit	ahina Loop					_	1.57	_	mJ	

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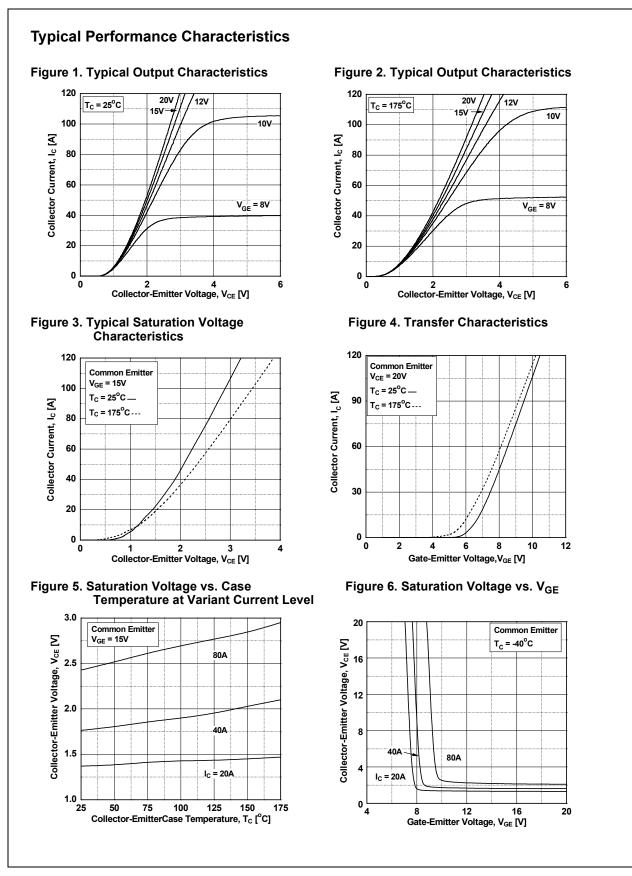
Electrical Characteristics of the IGBT (Continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge		-	119	-	nC
Q _{ge}	Gate to Emitter Charge	V _{CE} = 400V, I _C = 40A, V _{GE} = 15V	-	13	-	nC
Q _{gc}	Gate to Collector Charge	VGE - 10V	-	58	-	nC

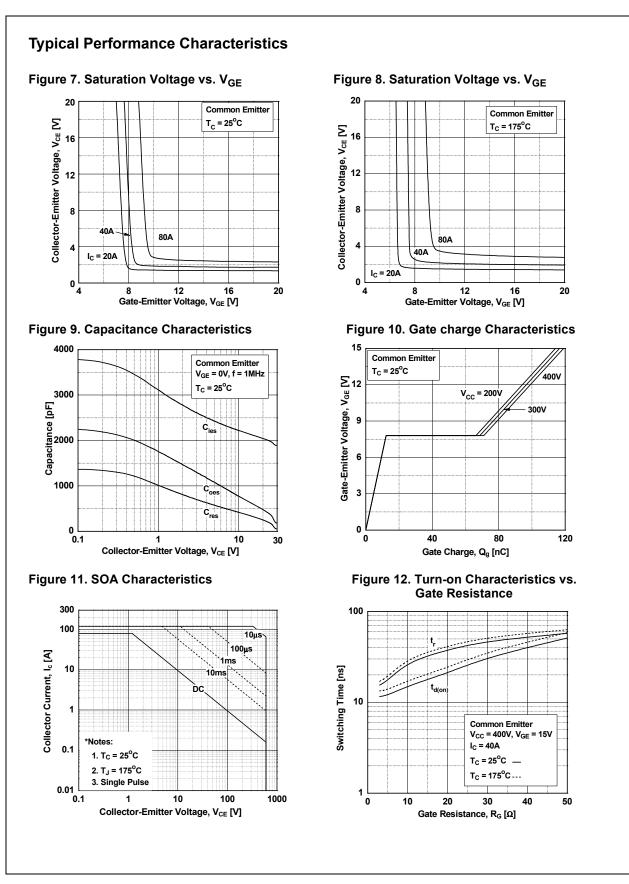
Electrical Characteristics of the Diode $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 20A	T _C = 25 ^o C	-	2.3	-	V
• FIM		1- 2011	T _C = 175 ^o C	-	1.67	-	
E _{rec}	Reverse Recovery Energy		T _C = 175 ^o C	-	48.9	-	uJ
t	Diode Reverse Recovery Time	I _F =20A, dI _F /dt = 200A/μs	T _C = 25°C	-	36	-	ns
۲r			T _C = 175 ^o C	-	110	-	
Q _{rr}	Diode Reverse Recovery Charge		T _C = 25 ^o C	-	46.8	-	nC
≪ll	block hover to very charge		T _C = 175 ^o C	-	445	-	

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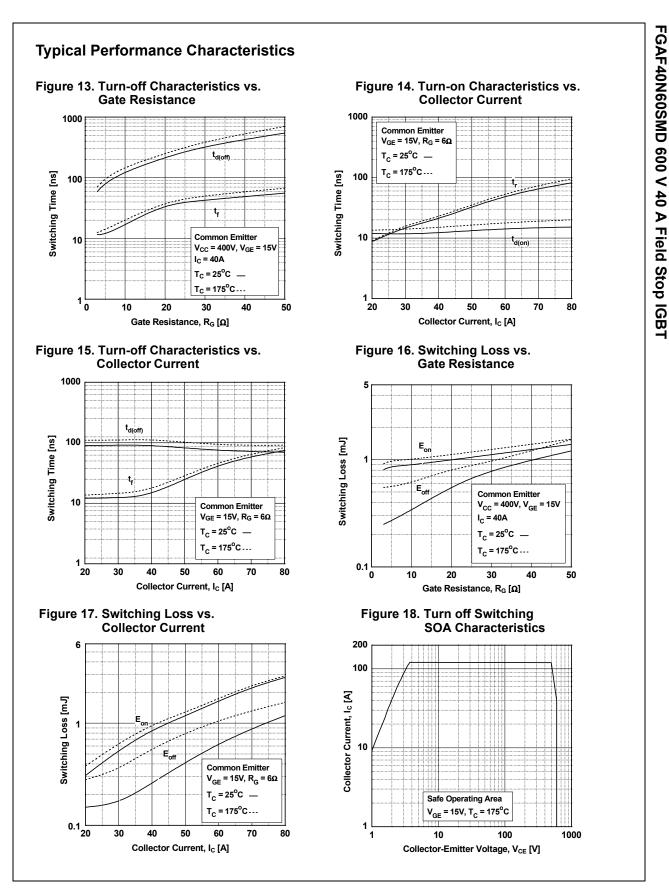


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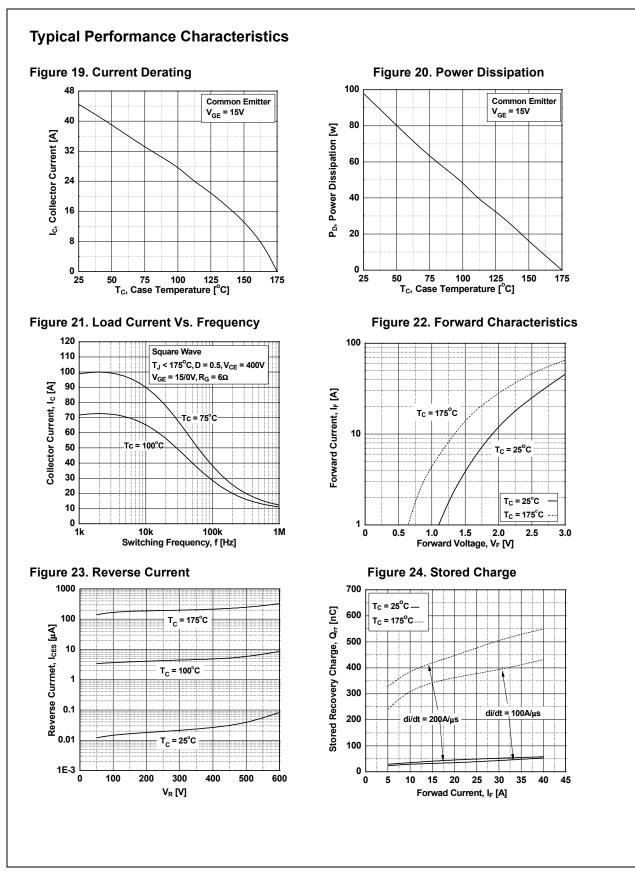
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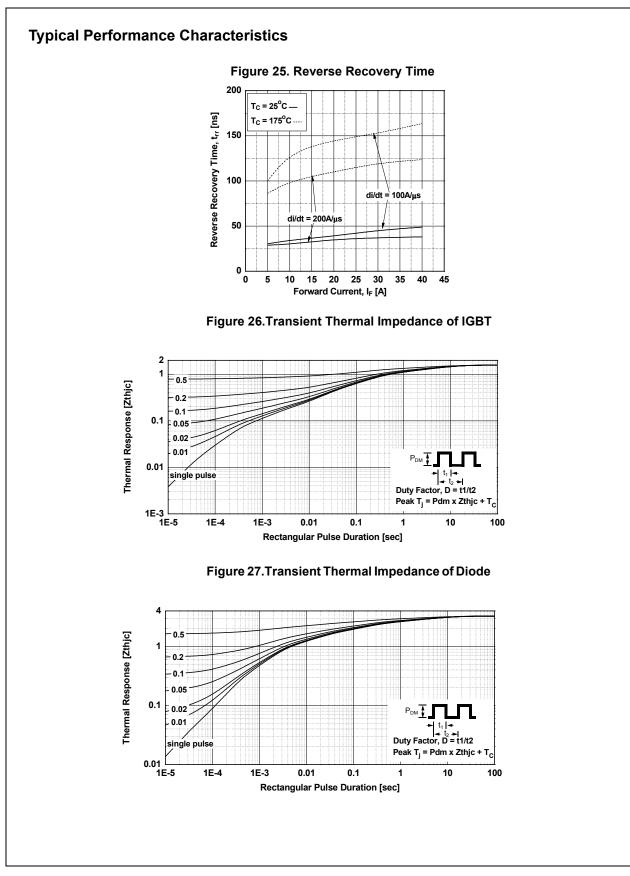


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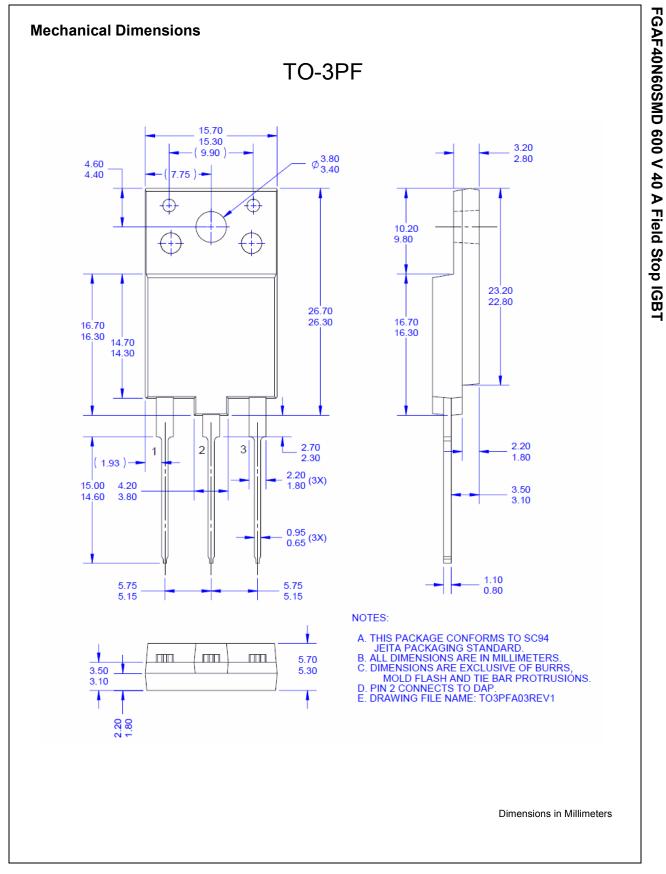
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Datasheet Identification	Product Status	Definition
Advance Information Formative / In E		Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
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